



CURRENT FLOW AT THE INTERFACE OF COPPER AND POLYETHYLENE IN HIGH-VOLTAGE APPARATUS

By

Eng. Mohammed Ahmed El-Shahat Abo-Saleh

A Thesis Submitted to the
Faculty of Engineering at Cairo University
In partial Fulfillment of the
Requirements for the Degree of

DOCTOR OF PHILOSOPHY In Electrical Power and Machines Engineering

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Title of Thesis:

Current flow at the interface of copper and polyethylene in high-voltage apparatus.

Key Words:

Polyethylene – copper – interface –barrier to injection – dielectric constant.

Summary:

Computational quantum mechanics in the framework of density functional theory (DFT) is used to develop the interface model between Cu (111) and PE (001). The "bulk plus band line up" method and the projected density of states (PDOS) analysis are combined to calculate the actual barrier to charge injection. This combination of methods lead to finding new states appearing between the Fermi level of Cu and the conduction band of PE, which lowered the barrier to electrons injection. These states are due to morphological deformation that takes place in both the metal and the polymer at the interface. The most common chemical impurities that are normally found in PE are studied in this thesis to understand their impact on conduction mechanism. These impurities, such as carbonyl, vinyl, and conjugated double bond, produce trap states between the conduction and valence bands of PE, which reduce the barrier height to around the experimental value of 1 eV. The lowered barrier height increases the charge injection, which then facilitates the conduction mechanism. Variations in the dielectric constant at the interface are also a significant factor. The present study investigates the change in dielectric constant of PE at the interface with Cu using the microscopic polarization theory. It is concluded that the calculated current density using Schottky injection mechanism under a certain electric field and temperature does not only depend on the barrier height, but also on the relative dielectric constant at the interface, which in turn changed the current density and the conduction process.



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LIST OF SYMBOLS

λ Trap separation Electronic charge q \mathbf{E} Electric field J Current density Richardson constant A

 \mathbf{T} Temperature

 V_b Barrier to charge injection height

Boltzmann's constant K Dielectric constant 3

Free space dielectric constant 03Relative dielectric constant $\epsilon_{\rm r}$

Plank's constant h

Tunneling effective mass $\mathbf{m}_{\mathbf{T}}$

Electron affinity $\mathbf{E_a}$ a, b, c Lattice constant

Band gap

 $\begin{matrix}E_g\\V_b^{e}\\V_b^{h}\end{matrix}$ Electrons barrier height Holes barrier height WF Work function Particle mass m ∇^2 Laplacian operator Ψ Wavefunction $\mathbf{E_{T}}$ Total energy Potential energy $\mathbf{E}_{\mathbf{p}}$ Hamiltonian operator Ĥ

kinetic energy $\mathbf{E}_{\mathbf{k}}$ \mathbf{Z} Charge number

Locations of electron i $\mathbf{r_{i}}$ R_i Locations of nucleus j $\delta(\sigma_i, \sigma_i)$ Kronecker-Delta function Hartree-Fock Hamiltonian H_{HF}

 $\mathbf{E}_{\mathbf{P} \mathbf{x}}$ Exchange potential Hartree potential E_{P Hartree} Correlation potential $\mathbf{E}_{\mathbf{P}\,\mathbf{c}}$ Electron density n(r)

External potential energy E_{P ext}

F[n]Global functional

 $\mathbf{E}_{\mathbf{xc}}$ Exchange-correlation energy Khon and Sham Hamiltonian HKS E_{PKS} Effective potential of KS

Basis set functions $\emptyset_{\mathbf{k}}$ Constant coefficients C_{k} Size of a basis sets L **Cutoff radius** $\mathbf{r_c}$

 $E_{vac} \\$ Vacuum level $\mathbf{E_f}$ Fermi level P Polarization

Induced charge density

 $\begin{array}{c} \rho_{ind} \\ E_{loc} \\ E_{ext} \end{array}$ Localized field External field

LIST OF ABBREVIATIONS

PDOS Projected density of states **DFT Density Functional Theory** Conduction band minimum **CBM VBM** Valence band maximum **OE** Quantum Espresso PE Polyethylene Cu Copper Silver Ag Aluminum Al Au Gold

AuGoldPtPlatinumPdPalladiumSiSiliconSiO2Silicon oxide

SCLC Space-Charge-Limited Conduction XPS X-ray Photoelectron Spectroscope EELS Electron Energy Loss Spectroscope

LDA Local density approximation

GGA Generalized gradient approximation

HSE Heyd-Scuseria-Ernzerhof

HF Hybrid functionals

MCSCF Multi configuration self-consistent field

CI Configuration interaction

CC Coupled cluster

MP Perturbation theory by Møller and Plesset

HK Hohenberg and KohnKS Kohn and ShamSCF Self-consistent field

LCAO Linear Combination of Atomic Orbitals

PW Plane Waves
AS Atomic Sphere
CG Conjugate gradient

BFGS Broyden- Fletcher-Goldfarb-Shanno

MD Molecular Dynamics DOS Density of states

GDIIS Geometric direct inversion in the iterative subspace

CP Car-Parrinello

PWSCF Plane-Wave Self-Consistent Field
PAW Projector Augmented Waves
PBE Perdew-Burke-Ernzerhof
FCC Face centered cubic
PEA Pulsed electro-acoustic

ABSTRACT

Polymers are increasingly becoming the insulator of choice in various high voltage power apparatus, such as capacitors and cables. Under high operating fields conduction (leakage) currents in polymers contribute to the eventual breakdown of the insulator, thus determining its active life time. A barrier to charge injection at polymer/metal interface is a key to understanding the high field conduction in cables and supercapacitors. The conduction mechanism of injected currents is influenced by barriers to charge injection and also by possible variations in the dielectric constant at the interface. The present work investigates barriers to charge injection at the atomic level at the interface of copper and polyethylene (PE), one of the most dominant material combinations in the power industry. Emphasis is carried out in this work on morphological deformation.

Computational quantum mechanics in the framework of density functional theory (DFT) is used to develop the interface model between Cu (111) and PE (001) in the light of previous DFT studies on the interface of PE with Pt, Au, and Ag in terms of the absolute barriers to holes and electrons injection. The "bulk plus band line up" method and the projected density of states (PDOS) analysis are combined to calculate the actual barrier to charge injection, which was not well identified in similar studies. This combination of methods lead to finding new states appearing between the Fermi level of Cu and the conduction band of PE, which lowered the barrier to electrons injection. These states are due to morphological deformation that takes place in both the metal and the polymer at the interface. The present work stresses the importance of considering morphological deformation in lowering the barriers to charge injection in soft metal which is less considered as compared to chemical impurities.

The most common chemical impurities that are normally found in PE are studied in this thesis to understand their impact on conduction mechanism. These impurities, such as carbonyl, vinyl, and conjugated double bond, produce trap states between the conduction and valence bands of PE, which reduce the barrier height to around the experimental value of 1 eV. The lowered barrier height increases the charge injection, which then facilitates the conduction mechanism. This work recognizes the fact that the barrier height is not the sole factor affecting conduction. Variations in the dielectric constant at the interface are also a significant factor. The present study investigates the change in dielectric constant of PE at the interface with Cu using the microscopic polarization theory. It is concluded that the calculated current density using Schottky injection mechanism under a certain electric field and temperature does not only depend on the barrier height, but also on the relative dielectric constant at the interface, which in turn changed the current density and the conduction process.